

Nch 40V 40A Power MOSFET

Datasheet

V _{DSS}	40V
R _{DS(on)} (Max.)	12.6mΩ
Ι _D	±40A
P _D	33W

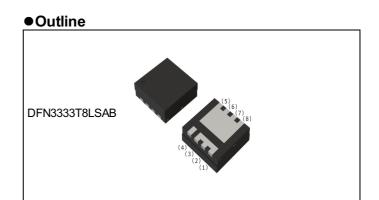
Features

Application

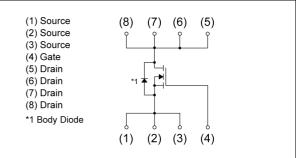
- 1) Wettable Flanks Product
- 2) AEC-Q101 Qualified

ADAS/Info./Lighting/Body

3) 100% Avalanche tested



Inner circuit



Packaging specifications

Туре	Packing	Embossed Tape
	Reel size (mm)	330
	Tape width (mm)	12
	Quantity (pcs)	3000
	Taping code	TCB
	Marking	G04DBK

• Absolute maximum ratings (T_a = 25°C ,unless otherwise specified)

Parameter	Symbol	Value	Unit		
Drain - Source voltage		V _{DSS}	40	V	
Continuous drain current V _{GS} = 10V		۱ _D *1	±40	А	
Pulsed drain current	^{*2}	±80	А		
Gate - Source voltage		V _{GSS}	±20	V	
Avalanche current, single pulse		۱ _{AS} *3	9.2	А	
Avalanche energy, single pulse		E _{AS} *3	6.4	mJ	
Power dissipation		P _D ^{*1}	33	W	
Junction temperature		Tj	175	°C	
Operating junction and storage te	T _{stg}	-55 to +175	°C		

•Thermal resistance

Parameter	Symbol	Values			Linit
		Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R _{thJC} *1	-	-	4.5	°C/W

•Electrical characteristics (T_a = 25°C)

Demonster	Sumbol	Que d'élana	Values			1.1:4
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 1mA	40	-	-	V
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_{i}} I_{D} = 1 mA$		-	21	-	mV/°C
Zero gate voltage drain current	I_{DSS} V_{DS} = 40V, V_{GS} = 0V		-	-	1	μA
Gate - Source leakage current	I_{GSS} $V_{GS} = \pm 20V, V_{DS} = 0V$		-	-	±500	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{GS(th)}$ $V_{DS} = V_{GS}, I_D = 200 \mu A$		-	2.5	V
Gate threshold voltage temperature coefficient	$\frac{\Delta V_{GS(th)}}{\Delta T_j}$	I _D = 200μA referenced to	-	-4.9	-	mV/°C
Static drain - source	D *4	V _{GS} = 10V, I _D = 20A	-	9.7	12.6	
on - state resistance	$R_{DS(on)}^{*4}$	V _{GS} = 4.5V, I _D = 10A	-	17.1	23.9	mΩ
Gate resistance	R _G f = 1MHz, open drain		-	4.4	-	Ω
Forward Transfer Admittance	Y _{fs} ^{*4}	V _{DS} = 5V, I _D = 10A	6.4	-	-	S

*1 T_c=25°C, Limited only by maximum temperature allowed.

*2 Pw≤10 μ s , Duty cycle≤1%

*3 L \simeq 0.1mH, V_{DD} = 20V, R_G = 25 Ω , Starting T_j = 25°C Fig.3-1,3-2

*4 Pulsed



•Electrical characteristics (T_a = 25°C)

Deremeter	Cumphal	Conditions	Values			Linit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Input capacitance	C _{iss}	V _{GS} = 0V	-	345	-		
Output capacitance	C _{oss}	V _{DS} = 20V	-	160	-	pF	
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	36	-		
Turn - on delay time	t _{d(on)} *4	$V_{DD} \simeq 20V, V_{GS}$ = 10V	-	6.7	-		
Rise time	t _r *4	I _D = 10A	-	4.9	-		
Turn - off delay time	t _{d(off)} *4	$R_L \simeq 2\Omega$	-	20.0	-	ns	
Fall time	t _f *4	R _G = 1Ω	-	3.8	-		

• Gate charge characteristics ($T_a = 25^{\circ}C$)

Deremeter	Currence of	Conditions		Values			l lait		
Parameter	Symbol			Min.	Тур.	Max.	Unit		
Total gata abarga	O *4		V _{GS} = 10V	-	7.6	-			
Total gate charge	Qg ^{*4}	Qg		$V_{DD} \simeq 20V$		-	4.2	-	nC
Gate - Source charge	Q _{gs} *4	Q _{gs} *4	I _D = 10A	V _{GS} = 4.5V	-	1.7	-	nc	
Gate - Drain charge	Q _{gd} *4			-	1.4	-			

•Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Deremeter	Symbol	Conditions	Values			Unit
Parameter	Symbol	nbol Conditions		Тур.	Max.	Unit
Continuous forward current	I _S *1	T _a = 25°C	-	-	27	А
Pulse forward current	I _{SP} *2	$T_a = 25 C$	-	-	80	А
Forward voltage	V _{SD} *4	V _{GS} = 0V, I _S = 20A	-	-	1.2	V
Reverse recovery time	t _{rr} *4	I _S = 10A, V _{GS} =0V	-	26	-	ns
Reverse recovery charge	Q _{rr} *4	di/dt = 100A/µs	-	17	-	nC



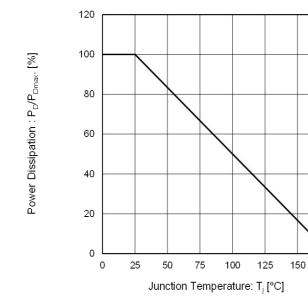


Fig.1 Power Dissipation Derating Curve

1000 T_a = 25°C Operation in this area Single Pulse is limited by $R_{DS}(on)(V_{GS} = 10V)$ 100 Pw = 100µs 10 Pw = 1ms 1 0.1 0.01 0.1 10 100 1 Drain - Source Voltage : V_{DS} [V]

Drain Current : I_D [A]

175

Fig.2 Maximum Safe Operating Area

Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

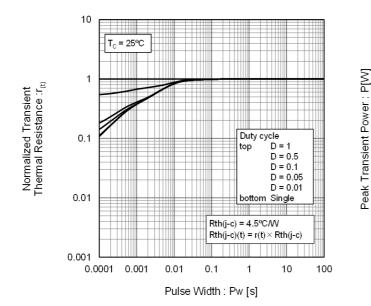
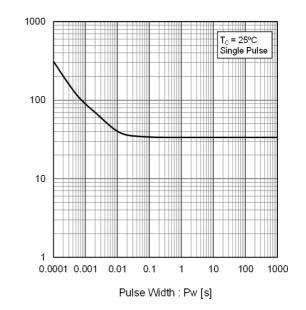
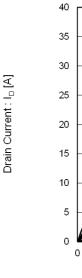


Fig.4 Single Pulse Maximum Power dissipation







0.1

Fig.5 Typical Output Characteristics(I)

_{GS} = 10V

V_{GS} = 4.5V

V_{GS} = 2.5V

0.2 0.3 0.4 0.5 0.6 0.7 0.8 0.9

Drain - Source Voltage : V_{DS} [V]

T_a = 25°C Pulsed

V_{GS} = 4.0V

V_{GS}= 3.5V

V_{GS}= 3.0V

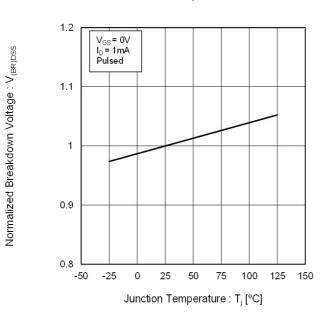
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Drain Current : I_D [A]

40 T_a = 25°C Pulsed . V_{GS}= 10V 35 √_{GS} = 4.5∨ 30 V_{GS}= 4.0V 25 V_{GS} = 3.5V 20 15 10 V_{GS}=3.0V 5 V_{GS} = 2.5V 0 0 1 2 3 4 5 6 7 8 9 10 Drain - Source Voltage : V_{DS} [V]

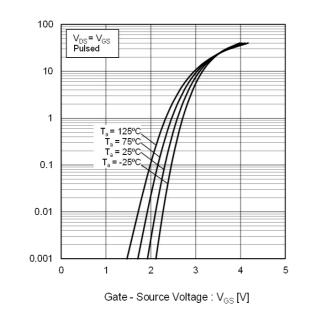
Fig.6 Typical Output Characteristics(II)

Fig.7 Breakdown Voltage vs. Junction Temperature









Gate Threshold Voltage : V_{GS(th)} [V]

Fig.8 Typical Transfer Characteristics

Fig.9 Gate Threshold Voltage vs. Junction Temperature

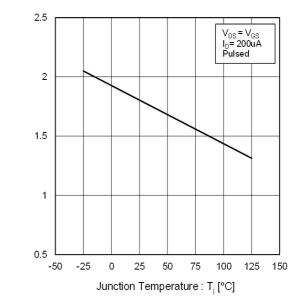
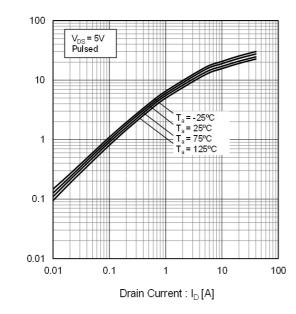


Fig.10 Forward Transfer Admittance vs. Drain Current



Drain Current : I_D [A]



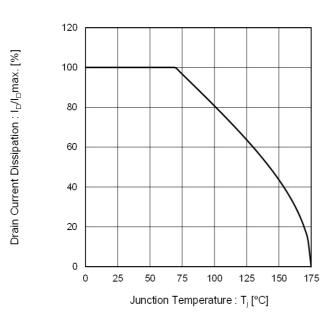


Fig.11 Drain Current Derating Curve



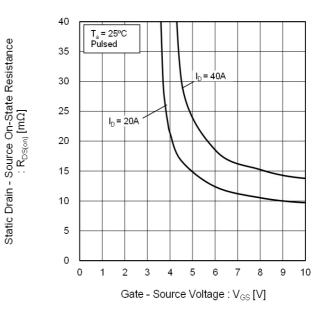
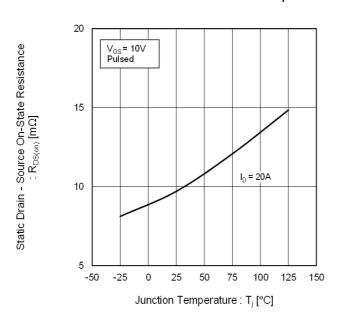


Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature







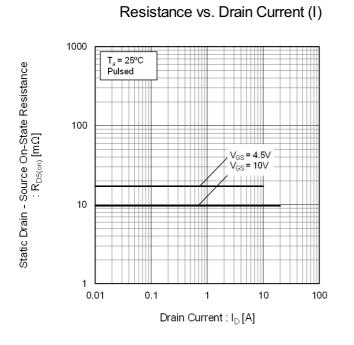


Fig.14 Static Drain - Source On - State

Fig.15 Static Drain - Source On - State Resistance vs. Drain Current (II)

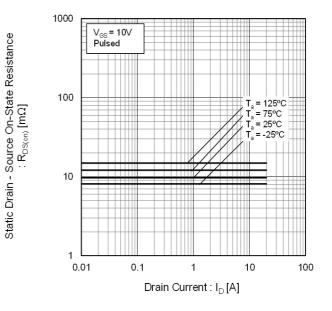
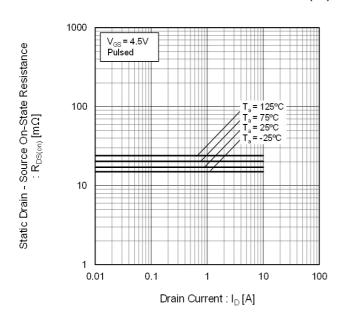
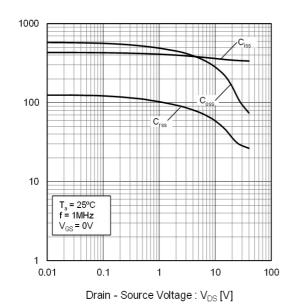


Fig.16 Static Drain - Source On - State Resistance vs. Drain Current (III)









Switching Time : t [ns]

Fig.17 Typical Capacitance vs. Drain - Source Voltage

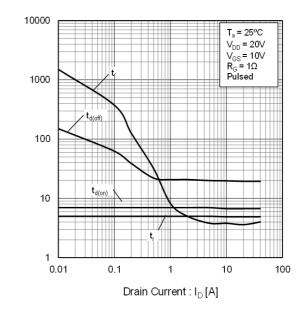


Fig.18 Switching Characteristics

Fig.19 Dynamic Input Characteristics

Gate - Source Voltage : V_{GS} [V]

Capacitance : C [pF]

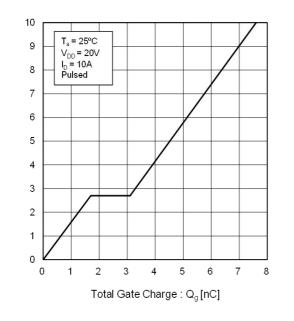
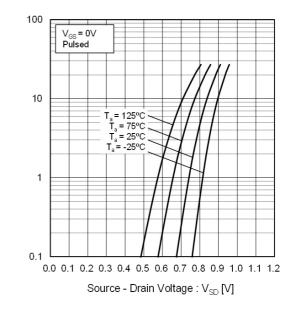


Fig.20 Source Current vs. Source Drain Voltage





Source Current : I_S [A]



Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

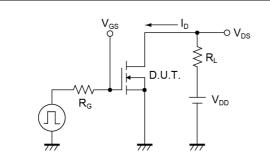


Fig.2-1 Gate Charge Measurement Circuit

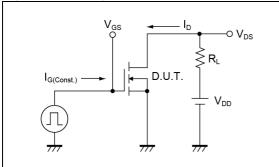


Fig.3-1 Avalanche Measurement Circuit

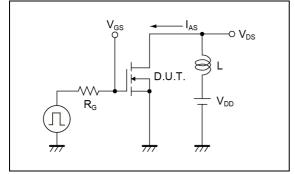


Fig.1-2 Switching Waveforms

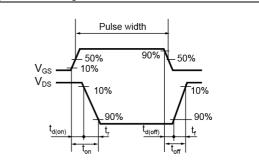


Fig.2-2 Gate Charge Waveform

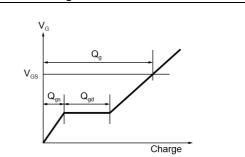
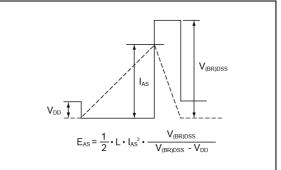


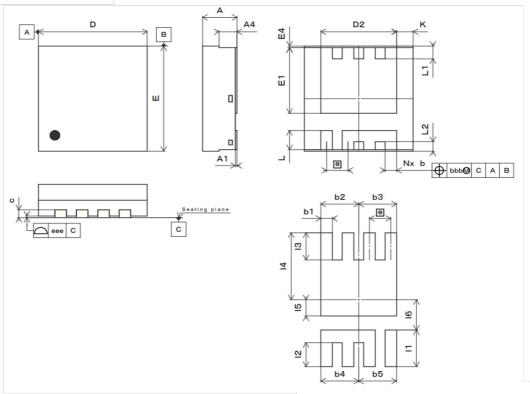
Fig.3-2 Avalanche Waveform





Dimensions

DFN3333T8LSAB



[reference pattern of soldering pads]

DIM	MILIME	TERS	INC	HES	
DIVI	MIN	MIN MAX		MAX	
А	0.900	1.100	0.035	0.043	
A1	0.000	0.050	0.000	0.002	
A4	0.300	<u> </u>	0.012		
b	0.250	0.450	0.010	0.018	
С	0.100	0.300	0.004	0.012	
D	3.200	3.400	0.126	0.134	
D2	2.200	2.400	0.087	0.094	
E	3.200	3.400	0.126	0.134	
E1	1.960	2.160	0.077	0.085	
E4	0.005	-	0.000	-	
е	0.6	50	0.0)26	
к	0.400	0.600	0.016	0.024	
L	0.500	0.700	0.020	0.028	
L1	0.300	0.500	0.012	0.020	
L2	0.200	0.400	0.008	0.016	
N			8		
DIM	MILIME	ETERS	INCHES		
Divi	MIN	MAX	MIN	MAX	
b1	0.3	350	0.0)14	
b2	1.1	150	0.0)45	
b3	1.1	150	0.0)45	
b4	1.1	150	0.045		
b5	1.150		0.045		
l1	1.150		0.045		
12	0.750		0.0)30	
I 3	0.850		0.033		
I 4	2.1	00	0.083		
15	0.5	510	0.0)20	
16	0.9	950	0.0)37	

Dimension in mm/inches



Notice

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CLASSⅣ	CLASSI	CLASSII	CLASSⅢ

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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
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- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
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- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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